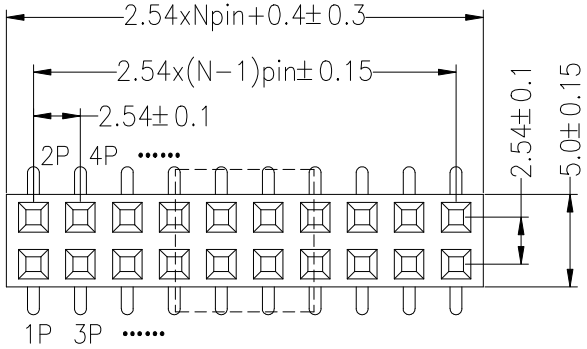
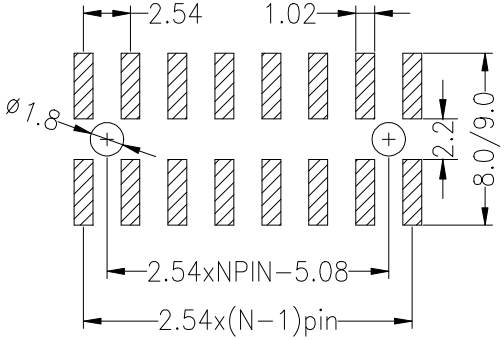
HSF RoHS FILE NO :E362810

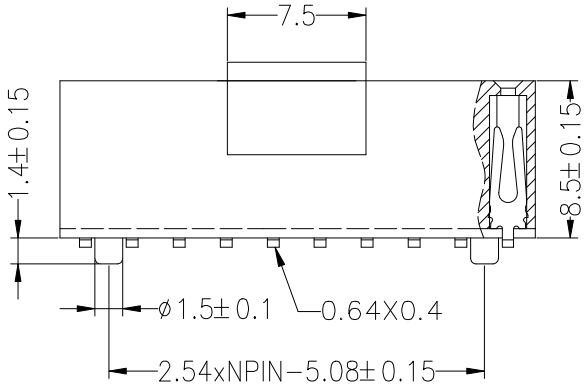
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

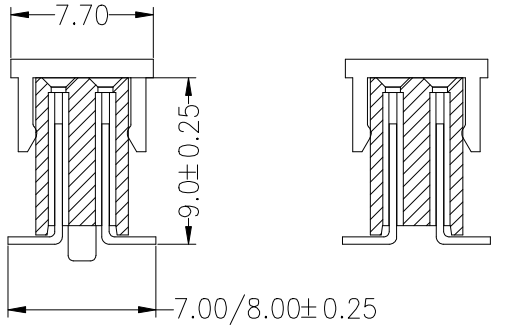
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)




Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)




## *Ordering Information*

**2285 02 XX X X XX M Y X 0X**

| | | | | | | |
|---|---|---|---|---|---|---|
| No.of Pins Per Row 2−40 | Insulator Material Option | Post | Contact Plating | | Packing | |
| | C=BK−PA6T | W=With Post | G1:Gold Flash | | 0=PE Bag | |
| | D=BK−PA46 | N=W/O Post | G2:1.5U" Gold | | A=Tray | |
| | E=BK−PA9T | | G3:2U" Gold | | T=Tube | |
| | F=BK−LCP | | G4:3U" Gold | | P=Tube+Cap | |
| | | | G5:5U" Gold | | R=Reel+Cap | |
| | | | S0:Gold Flash/Tin | | M=Reel+Mylar | |
| | | | SN:Tin | | | |

| REV | DATE | MODIFICATION DESCRIPTION | CHANGE |
|---|---|---|---|
| | | | |
| | | | |
| | | | |
| A0 | 2021.11.10 | NEW DRAWING | |

| OPERATION | | DRAW | Liu Miao | 21.11.10 |
|---|---|---|---|---|
| X.X | ±0.30 | | | |
| X.XX | ±0.20 | CHECK | | |
| X.XXX | ±0.10 | | | |
| Angle | ±3° | APPROVE | | |
| DIM | TOL | | | |

| | |
|---|---|
| SCALE | FIT |
| UNIT | mm |
| SIZE | A4 |
| SHEET | 1/1 |
| PROJ. | |

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

| | |
|---|---|
| PART NO. | 228502XXXXXXMYX0X |
| TITLE: | 2.54PF H8.5mm 2xNpin SMT W7.0/8.0 |